BC212, BC212B, BC213

Amplifier Transistors

PNP Silicon



ON Semiconductor[™]

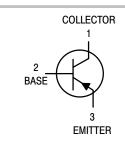
http://onsemi.com

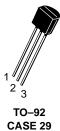
MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage BC212 BC213	VCEO	-50 -30	Vdc
Collector-Base Voltage BC212 BC213	VCBO	-60 -45	Vdc
Emitter-Base Voltage	VEBO	-5.0	Vdc
Collector Current – Continuous	IC	-100	mAdc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	PD	350 2.8	mW mW/°C
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	1.0 8.0	Watts mW/°C
Operating and Storage Junction Temperature Range	TJ, T _{stg}	–55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	R _{θJA}	357	°C/W
Thermal Resistance, Junction to Case	R _{θJC}	125	°C/W





STYLE 17

MARKING DIAGRAMS



WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
BC212	TO-92	5000 Units/Box
BC212B	TO-92	5000 Units/Box
BC212BRL1	TO-92	2000/Tape & Reel
BC212BZL1	TO-92	2000/Ammo Pack
BC213	TO-92	5000 Units/Box

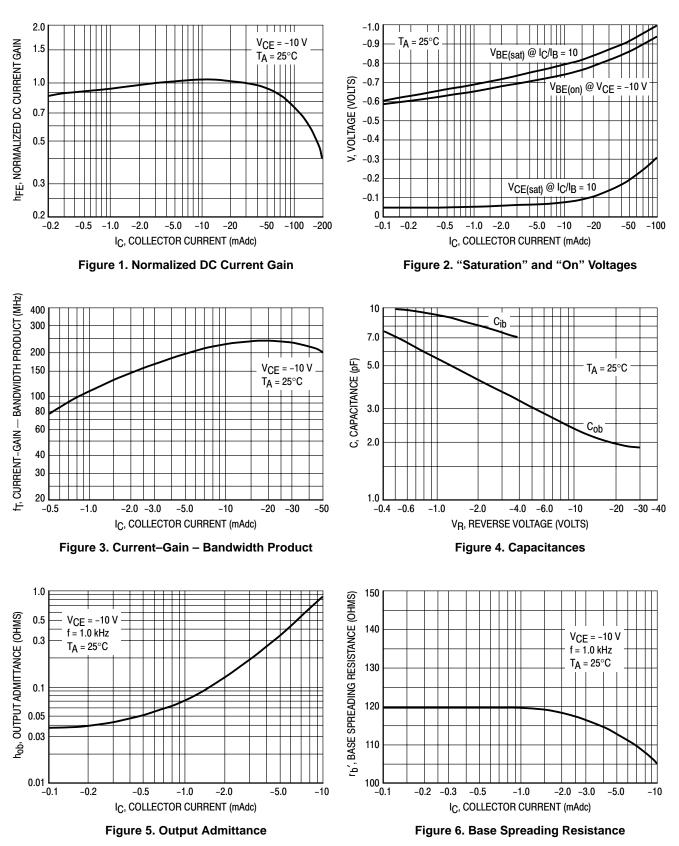
BC212, BC212B, BC213

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
Collector–Emitter Breakdown Voltage $(I_C = -2.0 \text{ mAdc}, I_B = 0)$	BC212 BC213	V _(BR) CEO	50 30			Vdc
Collector–Base Breakdown Voltage ($I_C = -10 \mu A$, $I_E = 0$)	BC212 BC213	V _(BR) CBO	-60 -45			Vdc
Emitter–Base Breakdown Voltage (I _E = -10μ Adc, I _C = 0)	BC212 BC213	V _{(BR)EBO}	-5 -5			Vdc
Collector–Emitter Leakage Current $(V_{CB} = -30 \text{ V})$	BC212 BC213	ICBO			-15 -15	nAdc
Emitter–Base Leakage Current ($V_{EB} = -4.0 \text{ V}, I_C = 0$)	BC212 BC213	IEBO			-15 -15	nAdc
ON CHARACTERISTICS					•	
DC Current Gain (I _C = -10μ Adc, V _{CE} = -5.0 Vdc)	BC212 BC213	hFE	40 40			-
$(I_{C} = -2.0 \text{ mAdc}, V_{CE} = -5.0 \text{ Vdc})$	BC212 BC213		60 80			
(I _C = -100 mAdc, V _{CE} = -5.0 Vdc) (Note 1.)	BC212 BC213		_ _	120 140		
Collector–Emitter Saturation Voltage ($I_C = -10$ mAdc, $I_B = -0.5$ mAdc) ($I_C = -100$ mAdc, $I_B = -5.0$ mAdc) (Note 1.)		V _{CE(sat)}		-0.10 -0.25		Vdc
Base–Emitter Saturation Voltage ($I_C = -100 \text{ mAdc}, I_B = -5.0 \text{ mAdc}$)		V _{BE(sat)}	_	-1.0	-1.4	Vdc
Base–Emitter On Voltage (I _C = -2.0 mAdc, V _{CE} = -5.0 Vdc)		V _{BE(on)}	-0.6	-0.62	-0.72	Vdc
DYNAMIC CHARACTERISTICS				•		•
Current–Gain – Bandwidth Product ($I_C = -10$ mAdc, $V_{CE} = -5.0$ Vdc, f = 100 MHz)	BC212 BC213	fT	-	280 360		MHz
Common–Base Output Capacitance ($V_{CB} = -10 \text{ Vdc}, I_C = 0, f = 1.0 \text{ MHz}$)		C _{ob}	-	-	6.0	pF
Noise Figure (I _C = -0.2 mAdc, V _{CE} = -5.0 Vdc, R _S = 2.0 k Ω , f = 1.0 kHz, f = 200 Hz)	BC212, BC213	NF	-	_	10	dB
Small–Signal Current Gain (I _C = –2.0 mAdc, V _{CE} = –5.0 Vdc, f = 1.0 kHz)	BC212 BC213 BC212B	h _{fe}	60 80 200		- - 400	-

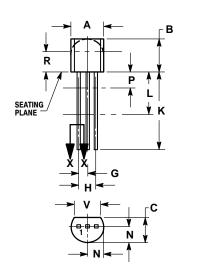
1. Pulse Test: Tp 300 s, Duty Cycle 2.0%.

BC212, BC212B, BC213



PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AL**





NOTES:

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. 3.

T14-304, 1902. CONTROLLING DIMENSION: INCH. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED. LEAD DIMENSION IS UNCONTROLLED IN P AND

4. BEYOND DIMENSION K MINIMUM

	INCHES		MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.045	0.055	1.15	1.39	
н	0.095	0.105	2.42	2.66	
J	0.015	0.020	0.39	0.50	
K	0.500		12.70		
L	0.250		6.35		
N	0.080	0.105	2.04	2.66	
Р		0.100		2.54	
R	0.115		2.93		
v	0.135		3.43		

STYLE 17: PIN 1. COLLECTOR 2. BASE 3. EMITTER

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